0.5 to 6.0 GHz High Power SPDT Switch



Features

Control voltage :

$$VC(H) = 1.8 \text{ to } 5.3 \text{ V } (3.0 \text{V TYP.})$$

 $VC(L) = -0.2 \text{ to } 0.2 \text{ V } (0 \text{V TYP.})$

• Low insertion loss:

$$\begin{split} L_{ins1} &= 0.30 \text{ dB TYP.} @ f = 0.5 \text{ to } 2.0 \text{ GHz} \\ L_{ins2} &= 0.35 \text{ dB TYP.} @ f = 2.0 \text{ to } 2.5 \text{ GHz} \\ L_{ins3} &= 0.40 \text{ dB TYP.} @ f = 2.5 \text{ to } 3.8 \text{ GHz} \\ L_{ins4} &= 0.45 \text{ dB TYP.} @ f = 3.8 \text{ to } 6.0 \text{ GHz} \end{split}$$

High isolation :

ISL1 = 32 dB TYP. @
$$f = 0.5$$
 to 2.0 GHz
ISL2 = 32 dB TYP. @ $f = 2.0$ to 2.5 GHz
ISL3 = 32 dB TYP. @ $f = 2.5$ to 3.8 GHz
ISL4 = 26 dB TYP. @ $f = 3.8$ to 6.0 GHz

Handling power :

$$P_{in(0.5dB)} = +34 \text{ dBm TYP.}$$

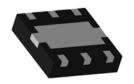
@ VC(H) = 3.0 V, VC(L) = 0 V

Package

6-pin Thin SON Package (XS03) (1.5mm x 1.5mm x 0.37mm)

Description

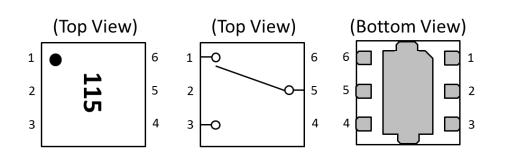
 The CKRF6415XS03 is a GaAs MMIC SPDT(Single Pole Double Throw) switch which was developed for WiMAX and wireless LAN



Applications

• WiMAX and wireless LAN (IEEE802.11a/b/g/n/ac), etc.

Pin Configuration and Internal Block Diagram



Pin No.	Pin Name
1	RF1
2	GND
3	RF2
4	VC2
5	RFC
6	VC1

Remark Exposed pad: GND

Ordering Information

Part Number	Order Number	Package	Marking	Supplying Form
CKRF6415XS03-C2	CKRF6415XS03-C2	6-pin TSON	115	•Embossed tape 8 mm wide
		(Pb-Free)		•Pin 1, 6 face the perforation
				side of the tape
				·Qty 10 kpcs/reel

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Absolute Maximum Ratings

(TA = +25°C, unless otherwise specified)

Parameter	Symbol	Rating	Unit
Control Voltage	VC	6.0 ^{Note 1}	V
Input Power	Pin	+34.5 ^{Note 2}	dBm
Operating Ambient Temperature	T _A	-45~+85	$^{\circ}$
Storage Temperature	T _{stg}	-55~+150	$^{\circ}$

Note

1. |VC1 - VC2|≦6.0V

2. 3.0V≦|VC1 - VC2|≦5.0V

Recommended Operating Range

(TA = +25°C, unless otherwise specified)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Operating Frequency	f	0.5	-	6.0	GHz
Switch Control Voltage (H)	VC(H)	+1.8	+3.0	+5.3	V
Switch Control Voltage (L)	VC(L)	-0.2	0	+0.2	V

Truth Table

VC1	VC2	RFC-RF1	RFC-RF2
High	Low	ON	OFF
Low	High	OFF	ON

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Electrical Characteristics 1

Symbol	Condition	MIN	TYP	MAX	Unit
,					dB
_					
L _{INS2}	f=2.0 to 2.5GHz		0.35	0.55	dB
L _{INS3}	f=2.5 to 3.8GHz		0.40	0.60	dB
L _{INS4}	f=3.8 to 6.0GHz		0.45	0.70	dB
ISL1	f=0.5 to 2.0GHz Note 1	29	32		dB
ISL2	f=2.0 to 2.5GHz	29	32		dB
ISL3	f=2.5 to 3.8GHz	29	32		dB
ISL4	f=3.8 to 6.0GHz	23	26		dB
RL1	f=0.5 to 2.0GHz Note 1	15	20		dB
RL2	f=2.0 to 2.5GHz	15	20		dB
RL3	f=2.5 to 6.0GHz	10	15		dB
P _{in(0.1dB)}	f=0.5 to 2.0GHz Note 1		+32		dBm
	f=2.0 to 6.0GHz		+31		dBm
	f=0.5 to 6.0GHz Note 1		. 25		-ID
	VC(H)=5.0V		+35		dBm
P _{in(0.5dB)}	f=0.5 to 2.0GHz Note 1		+34		dBm
	f=2.0 to 6.0GHz		+34		dBm
IIP ₃	f=2.5GHz, 2-tone		60		dPm
	1MHz Spacing		60		dBm
2f0	f=2.5GHz, P _{in} =+20dBm		-90		dBc
	f=6.0GHz, P _{in} =+20dBm		-90		dBc
3f0	f=2.5GHz, P _{in} =+20dBm		-90		dBc
	f=6.0GHz, P _{in} =+20dBm		-90		dBc
	L _{INS3} L _{INS4} ISL1 ISL2 ISL3 ISL4 RL1 RL2 RL3 Pin(0.1dB) IIP ₃	L _{INS1} f=0.5 to 2.0GHz Note 1 L _{INS2} f=2.0 to 2.5GHz L _{INS3} f=2.5 to 3.8GHz L _{INS4} f=3.8 to 6.0GHz ISL1 f=0.5 to 2.0GHz Note 1 ISL2 f=2.0 to 2.5GHz ISL3 f=2.5 to 3.8GHz ISL4 f=3.8 to 6.0GHz RL1 f=0.5 to 2.0GHz Note 1 RL2 f=2.0 to 2.5GHz RL3 f=2.5 to 6.0GHz RL3 f=2.5 to 6.0GHz P _{in(0.1dB)} f=0.5 to 2.0GHz Note 1 f=2.0 to 6.0GHz f=0.5 to 6.0GHz f=0.5 to 6.0GHz VC(H)=5.0V P _{in(0.5dB)} f=0.5 to 2.0GHz Note 1 f=2.0 to 6.0GHz IIP ₃ f=2.5GHz, 2-tone 1MHz Spacing 2f0 f=2.5GHz, P _{in} =+20dBm f=6.0GHz, P _{in} =+20dBm	L _{INS1}	$\begin{array}{cccccccccccccccccccccccccccccccccccc$	L _{INS1} f=0.5 to 2.0GHz Note 1 0.30 0.50 L _{INS2} f=2.0 to 2.5GHz 0.35 0.55 L _{INS3} f=2.5 to 3.8GHz 0.40 0.60 L _{INS4} f=3.8 to 6.0GHz 0.45 0.70 ISL1 f=0.5 to 2.0GHz Note 1 29 32 ISL2 f=2.0 to 2.5GHz 29 32 ISL3 f=2.5 to 3.8GHz 29 32 ISL4 f=3.8 to 6.0GHz 29 32 ISL4 f=0.5 to 2.0GHz Note 1 15 20 RL1 f=0.5 to 2.0GHz Note 1 15 20 RL2 f=2.0 to 2.5GHz 15 20 RL3 f=2.5 to 6.0GHz 10 15 Pin(0.1dB) f=0.5 to 2.0GHz Note 1 +32 f=2.0 to 6.0GHz +31 f=0.5 to 6.0GHz +31 f=0.5 to 6.0GHz Note 1 +34 f=2.0 to 6.0GHz +34 IIP ₃ f=2.5GHz, 2-tone 1 60 1MHz Spacing 60 2f0 f=2.5GHz, Pin=+20dBm90 f=6.0GHz, Pin=+20dBm90 3f0 f=2.5GHz, Pin=+20dBm90

Note 1. DC block capacitance = 56pF at f=0.5 to 2.0GHz

Note 3. $P_{in(0.5dB)}$ is the measured input power level when the insertion loss increases 0.5dB more than that of the linear range.

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Note 2. $P_{in(0.1dB)}$ is the measured input power level when the insertion loss increases 0.1dB more than that of the linear range.

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Electrical Characteristics 2

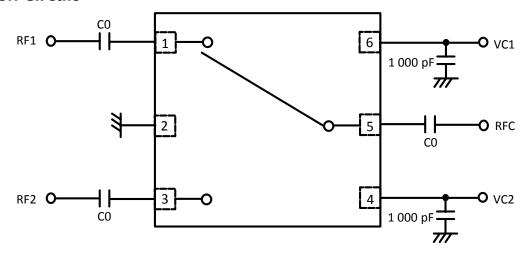
Parameter	Symbol	Condition	MIN.	TYP.	MAX.	Unit
Error Vector Magnitude		802.11a, 64QAM, 54Mbps, Pin≦+25dBm		0.5		%
E	EVM	802.11g, 64QAM, 54Mbps, Pin≦+25dBm		0.5		%
		802.11ac, 256QAM, MCS9, 80MHz, Pin≤+25dBm		0.5		%
Switch Control Current	I_{CONT}	RF none	1	2	10	uA
Switching Speed	T _{SW}	50% CTL to 90/10% RF		100	250	ns

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Evaluation Circuit

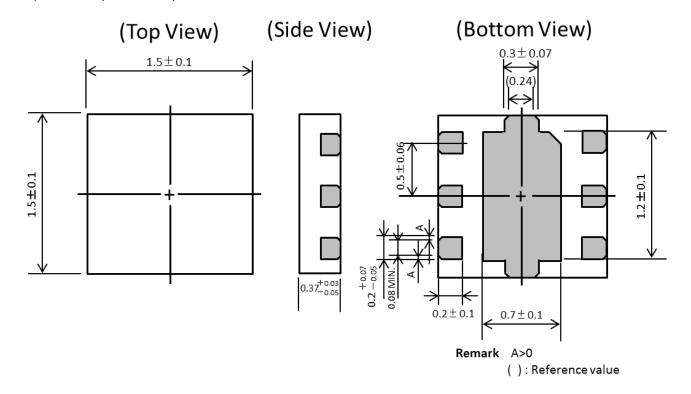


Note C0: 0.5 to 2.0 GHz 56pF: 2.0 to 6.0 GHz 8pF

The application circuits and their parameters are for reference only and are not intended for use in actual design-ins. This device is used it is necessary to use DC Block Capacitance.

Package Dimensions

6-pin TSON (Unit: mm)



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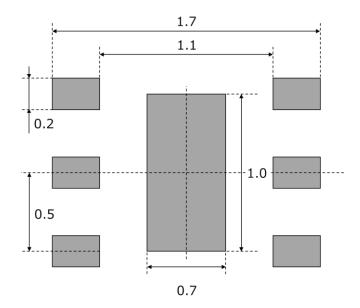
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PCB Layout Footprint

6-pin TSON (Unit: mm)



The PCB Layout Footprint in this document is for reference only.

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[Caution in the gallium arsenide (GaAs) product handling]

This product uses gallium arsenide (GaAs) of the toxic substance appointed in laws and ordinances. GaAs vapor and powder are hazardous to human health if inhaled or ingested.

- Do not dispose in fire or break up this product.
- Do not chemically make gas or powder with this product.
- When discard this product, please obey the law of your country.
- Do not lick the product or in any way allow it to enter the mouth.

[CAUTION]

Although this device is designed to be as robust as possible, ESD (Electrostatic Discharge) can damage this device. This device must be protected at all times from ESD. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD precautions should be used at all times.

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